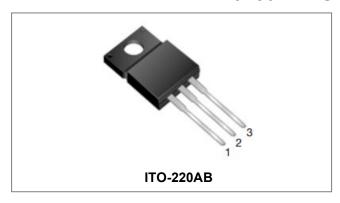




### MBRF10150CTL SCHOTTKY RECTIFIER



### **Features**

- 150°C T<sub>J</sub> operation
- Center tap configuration
- · Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### **Circuit Diagram**



### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

### **Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units	
Peak Repetitive Reverse Voltage	$V_{RRM}$	-			
Working Peak Reverse Voltage	$V_{RWM}$		150	V	
DC Blocking Voltage	V <sub>R</sub>				
Average Destified Forward Current		50% duty cycle @Tc=145°C, rectangular	5(Per Leg)	۸	
Average Rectified Forward Current	I <sub>F</sub> (AV)	wave form	10(Per Device)	Α	
Peak One Cycle Non-Repetitive	I <sub>FSM</sub>	8.3ms, Half Sine pulse	138	Α	
Surge Current(Per Leg)	IFSM	0.5ms, mail offic palse	130		

### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units	
Forward Voltage Drop(Per Leg)*	V <sub>F1</sub>	@ 3A, Pulse, T <sub>J</sub> = 25 °C	0.79	0.87	V	
		@ 5A, Pulse, T <sub>J</sub> = 25 °C	0.82	0.93	\ \	
	V <sub>F2</sub>	@ 3A, Pulse, T <sub>J</sub> = 125 °C	0.61	0.67	V	
		@ 5A, Pulse, T <sub>J</sub> = 125 °C	0.68	0.73	\ \	
Reverse Current(Per Leg)*	I <sub>R1</sub>	@V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 25 °C	0.002	1.0	mA	
	I <sub>R2</sub>	@V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 125 °C	1.5	7.0	mA	
Junction Capacitance(Per Leg)	Ст	$@V_R = 5V, T_C = 25  ^{\circ}C, f_{SIG} = 1MHz$	110	200	pF	
Series Inductance(Per Leg)	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH	
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs	
RSM Isolation Voltage (t = 1.0 second, R. H. < =30%, T <sub>A</sub> = 25 °C)	VISO	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction.	-	4500	V	
,		Clip mounting, the epoxy body is inside the heatsink.	-	3500		
		Screw mounting, the epoxy body is inside the heatsink.	-	1500		

Pulse width < 300 µs, duty cycle < 2%

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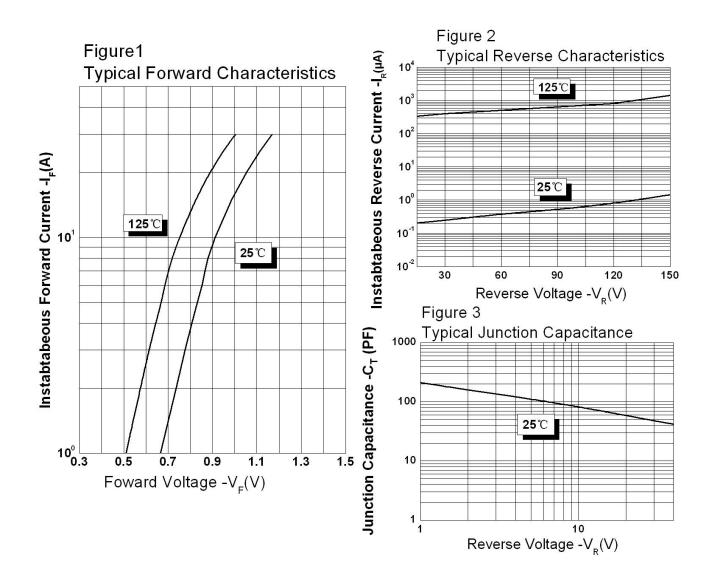




## **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	$T_J$	-	-55 to +150	°C
Storage Temperature	$T_{stg}$	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	$R_{ heta JC}$	DC operation	4.5	°C/W
Approximate Weight	wt	-	2	g
Case Style	ITO-220AB			

## **Ratings and Characteristics Curves**



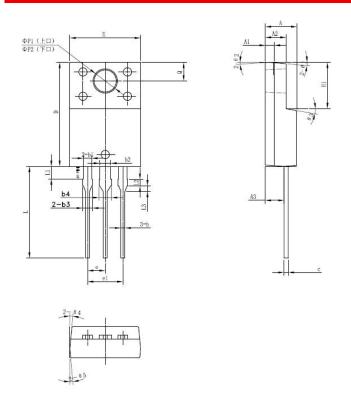
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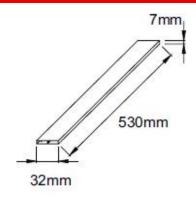


### **Mechanical Dimensions ITO-220AB**



SYMBOL	Millimeters			
STIMBUL	MIN.	TYP.	MAX.	
Α	4.30	4.50	4.70	
A1	1.10	1.30	1.50	
A2	2.80	3.00	3.20	
A3	2.50	2.70	2.90	
b	0.50	0.60	0.75	
b1	1.10	1.20	1.35	
b2	1.50	1.60	1.75	
b3	1.20	1.30	1.45	
b4	1.60	1.70	1.85	
С	0.50	0.60	0.75	
D	14.80	15.00	15.20	
E	9.96	10.16	10.36	
е		2.55		
e1		5.10		
H1	6.50	6.70	6.90	
L	12.70	13.20	13.70	
L1	1.60	1.80	2.00	
L2	0.80	1.00	1.20	
L3	0.60	0.80	1.00	
<b>ФР1(</b> 上□)	3.30	3.50	3.70	
<b>ΦP2</b> (下口)	2.99	3.19	3.39	
Q	2.50	2.70	2.90	
Θ1		5°		
Θ2		4°		
Θ3		10°		
Θ4		5°		
Θ5		5°		

### **Tube Specification**



## **Marking Diagram**



Where XXXXX is YYWWL

 MBR
 = Device Type

 F
 = Package type

 10
 = Forward Current (10A)

 150
 = Reverse Voltage (150V)

 CTL
 = Configuration

 SSG
 = SSG

 YY
 = Year

 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

### **Ordering Information**

Device	Package	Shipping
MBRF10150CTL	ITO-220AB(Pb-Free)	50 pcs/ tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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